L Number	Hits	Search Text	DD.	Tri
-	743		DB USPAT;	Time stamp
			US-PGPUB	2002/04/16 10:38
_	691	257/738.ccls.	USPAT:	2002/04/17 10 20
			US-PGPUB	2002/04/16 10:38
-	325663	conductive	USPAT:	2002/01/17/10/26
				2002/04/16 10:39
-	302573	adhesive	US-PGPUB	: 2002/04/17 10 20
			USPAT:	2002/04/16 10:39
-	262017	ball	US-PGPUB	2002/04/16 10 20
			USPAT;	2002/04/16 10:39
-	7790	conductive adj adhesive	US-PGPUB	1 2002/04/14 10 20
			USPAT:	2002/04/16 10:39
_	195	ball with (conductive adj adhesive)	US-PGPUB	. 2002/04/14 10:20
		and the conductive and addressive)	USPAT;	2002/04/16 10:39
-	0	(257/737.ccls. or 257/738.ccls.) with (ball with (conductive adj	US-PGPUB	2002/04/17 10 10
		adhesive))	USPAT:	2002/04/16 10:40 .
-	36	(257/737.ccls. or 257/738.ccls.) and (ball with (conductive adj adhesive))	US-PGPUB	2002/04/14 10 21
		(25 77 5 7.0013: 01 25 77 50.0013.) and (ball with (conductive adj adnesive))	USPAT:	2002/04/16 10:54
_	649	156/297.ccls.	US-PGPUB	2002/04/15 10 21
			USPAT;	2002/04/16 10:54
-	1	156/297.ccls. and (ball with (conductive adj adhesive))	US-PGPUB	2002/04/14 10 55
	-	(but with (conductive adj adilesive))	USPAT:	2002/04/16 10:55
_	47	156/297.ccls. and ball	US-PGPUB	2002/04/14
	.,	136/257.0013. dild buil	USPAT:	2002/04/16 11:00
-	131520	interconnect	US-PGPUB	0000000000
	131320	merconnect	USPAT:	2002/04/16 11:00
_	315994	insulating or insulation	US-PGPUB	000010111111111111111111111111111111111
	313774	insulating of insulation	USPAT;	2002/04/16 11:00
1-	207171	pad	US-PGPUB	
	20/1/1	pad	USPAT;	2002/04/16 11:01
1_	1	interconnect same (insulating or insulation) same pad same ball same	US-PGPUB	1
	•	(conductive adj adhesive)	USPAT;	2002/04/16 11:05
_	240	interconnect and (insulating or insulation) and pad and ball and	US-PGPUB	!
	240	(conductive adj adhesive)	USPAT;	2002/04/16 11:06
	12059	first adj (insulation or insulating)	US-PGPUB	
	12037	mst adj (msdiation of msdiating)	USPAT;	2002/04/16 11:07
-	12323	second adj (insulation or insulating)	US-PGPUB	2002/01/11
	12323	second adj (msdiation of msdiating)	USPAT:	2002/04/16 11:08
_	15	interconnect and (first adj (insulation or insulating)) and (second adj	US-PGPUB	1.000.00.00.00.00.00.00.00.00
	15	(insulation or insulating)) and pad and ball and (conductive adj adhesive)	USPAT;	2002/04/16 11:13
_	2810	(insulating or insulation) near hole	US-PGPUB	
	2010	(modiating of modiation) hear note	USPAT:	2002/04/16 11:13
-	0	((insulating or insulation) near hole) with (ball with (conductive adj	US-PGPUB	1.0000/04/24
	· ·	adhesive))	USPAT;	2002/04/16 11:13
-	0	((insulating or insulation) near hole) same (ball with (conductive adj	US-PGPUB	1 2002/04/15 14 12
	·	adhesive))	USPAT:	2002/04/16 11:13
-	2	((insulating or insulation) near hole) with (conductive adj adhesive)	US-PGPUB	: 3003/04/17 ** **
	~	(and addition) near note, with (conductive adj addiesive)	USPAT;	2002/04/16 11:14
-	6	((insulating or insulation) near hole) same (conductive adj adhesive)	US-PGPUB USPAT;	2002/04/16 11:26
	_	((""" and addition) near note; same (conductive adj addiesive)	US-PGPUB	2002/04/10 11:20
]_	4672600	EP "734059"		2002/04/16 11:27
		21 (6100)	USPAT;	2002/04/16 11:27
	1		US-PGPUB;	
			EPO; JPO;	
	ļ	•	DERWENT:	i 1
-	2	"EP 734059"	IBM_TDB	: : 2002/04/14 11 20
	-		USPAT:	2002/04/16 11:30
1		!	US-PGPUB;	•
	Ì		EPO: JPO:	
		·	DERWENT;	
	0	734059.URPN.	IBM_TDB USPAT	2002/04/17 11:30
-	673443	hole	USPAT;	2002/04/16 11:28
			US-PGPUB	2002/04/16 11:31
l			OB-LOUDING	

-	0	(hole near (conductive adj adhesive)) with ball	USPAT:	2002/04/16 11:31
			US-PGPUB	
-	1	(hole near (conductive adj adhesive)) same ball	USPAT;	2002/04/16 11:31
			US-PGPUB	
-	0	734059.URPN.	USPAT	2002/04/16 11:33
	i	1996-427343.NRAN.	DERWENT	: 2002/04/16 11:33 :
_	4	5960308.URPN.	USPAT	2002/04/16 11:34
-	2944	adhesive with ball	USPAT:	2002/04/17 13:20
			US-PGPUB	
-	673443	hole	USPAT;	2002/04/17 13:21
			US-PGPUB	1
-	10	((conductive adj adhesive) with ball) with hole	USPAT;	2002/04/17 13:21
			US-PGPUB	! !
-	195	(conductive adj adhesive) with ball	USPAT;	2002/04/17 13:25
			US-PGPUB	i
•	7346	conductive adj adhesive	EPO; JPO;	2002/04/17 14:20
	70.70	,	DERWENT:	k .
			IBM TDB	
-	244474	ball	EPO; JPO;	2002/04/17 14:20
		, · · · · · · · · · · · · · · · · · · ·	DERWENT:	1
			IBM TDB	
_	46	(conductive adj adhesive) with ball	EPO; JPO:	2002/04/17 14:44
			DERWENT:	
	, i		IBM TDB	1
	1	2000-161197.NRAN.	DERWENT	2002/04/17 14:29
-	1	6107109.pn.	¹ EPO; JPO;	2002/04/17 14:44
			DERWENT,	
			IBM TDB	1
	10	("5674785" "5677566" "5739585" "5763939" "5783461"	USPAT	2002/04/17 14:46
		"5811879" "5834945" "5885849" "5925930" "5956605").PN.	1	
_	35	("5046239" "5063177" "5166097" "5172050" "5229647"	USPAT	2002/04/17 14:47
		"5236551" "5249450" "5420520" "5426072" "5483741" "5487999"		
		"5495667" "5528080" "5541525" "5559444" "5578526"	•	•
		"5592736" "5607818" "5634267" "5674785" "5686317" "5716218"	· !	1
		"5756395" "5781022" "5783461" "5796264" "5801452"	}	
		"5815000" "5834945" "5869974" "5878485" "5896036" "5915977"		
		"5929647" "5931685").PN.		1
_	3	"5929522"	USPAT;	2002/04/17 14:55
-			US-PGPUB	!